

PATENT  
450134-04839

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kazuaki YAZAWA  
Filed: Filed Concurrently Herewith  
Title of Invention: HEAT DISSIPATING STRUCTURE FOR AN ELECTRONIC DEVICE

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INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Enclosed are copies of references which were cited in the Japanese Patent Office in connection with the corresponding Japanese patent application. Also enclosed is a copy of Form PTO-1449. Entry of this Information Disclosure Statement and an early examination on the merits are respectfully solicited.

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Respectfully submitted,

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	APPLICANT Kazuaki YAZAWA	
	FILING DATE Filed Concurrently Herewith	GROUP

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
	AL						
	AM						
	AN						
	AO						
	AP						

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)							
	AR		Patent Abstracts of Japan 09-212258 dated 08/15/97				
	AS		Allan D. Kraus et al., "DESIGN AND ANALYSIS OF HEAT SINKS", 1995 A Wiley-Interscience Publication, pages 286-291				
	AT		Akash Jain et al., "BUOYANCY-DRIVEN FLOW IN CHANNELS WITH IN-LINE PIN FINS" Proceedings of ASME NHTC'01, 35th National Heat Transfer Conference Anaheim, California, June 10-12, 2001, pages 1-8				
	AU		William K. Coxe III et al., "EXPERIMENTAL MODELING OF THE PASSIVE COOLING LIMIT OF NOTEBOOK COMPUTERS", 2002 Inter Society Conference on Thermal Phenomena, pages 15-21				
EXAMINER				DATE CONSIDERED			

\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.